

3D Sensing: Market and Industry Update

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Outline



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- Applications and market trends
 - Mobile
 - Consumer
 - Automotive
- Technology trends
 - Emerging technologies
 - Technology roadmap

- Industry and supply chain
 - Supply chain considerations and examples
 - ToF ecosystem
- 3D sensing market forecasts
 - 2022-2028 forecast
 - Industry outlook



Introduction



3D sensing technologies

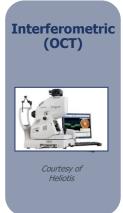


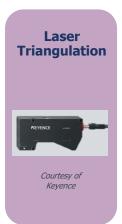
Single-frame 3D

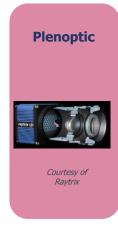












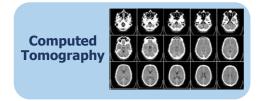


Multiple-frame 3D











Focus on high volume technologies



YOLE	Stereo vision	Structured light	Time-of-flight
Image resolution	Several MP	Max. 1-3 MP	Max. 1 MP
Depth range	Limited (up to 20m for drone)	Shorter (<1-2m)	Higher (up to 8m)
Hardware	Simple cameras; Complex system	Demanding illumination; Complex system	Simple illumination; Complex sensors
Computational power	High	Medium	Low
Limitations	May require illumination in low light, good for outdoor	Best indoors Need power	Best indoors Low resolution
Picture (example)		illuminator Camara Brago Courtesy of Apple	Diffuser SPAD sensor Courtesy of LGIT
Best suited for	Robotic & drone navigation	Short-range face recognition	3D mapping
Players (non-exhaustive)	SONY CIMIT STEREOLABS CITAMSUNG COMMITTEENS ONSEMI	Himox Imants vision OMNIVISION NAMUGA Multimedia Lab Namuga	Panasonic SONY Panasonic SONY ANALOG WHUTS PROBERT ANALOG WHUTS PROBERT ANALOG WHUTS PROBERT





Applications and market trends



Mobile 3D camera applications



Use-cases and opportunities for the **front** 3D camera

Easy unlocking







Morphing Augmented reality







Payment Facial recognition







Gaming Avatar







Enhanced video call





Thanks to Apple, face ID is the unbeatable unlocking experience.

Holographic displays







Better photography





Augmented reality







Gaming





Daily life





3D Picture



Market had a good start with Huawei, but now is led by Apple. We expect novel AR applications next.

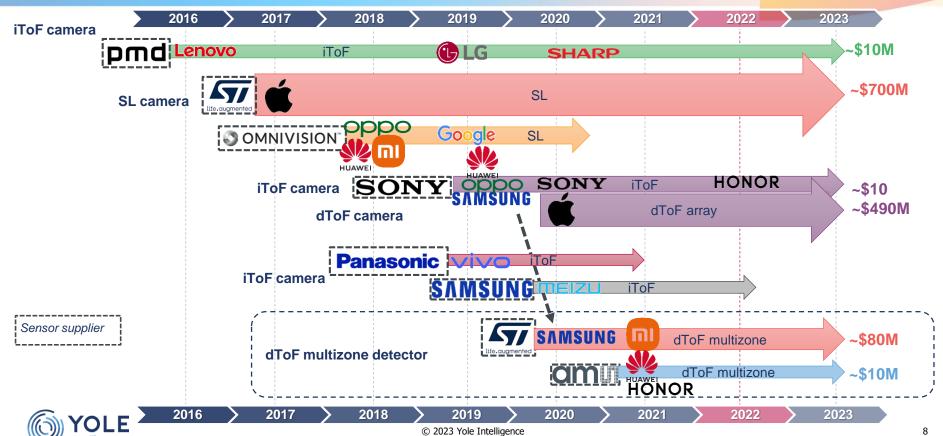
Others?





A brief history of 3D sensing design-wins in mobile – sensor level





3D sensing spreading into home appliances







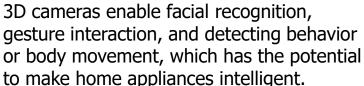
Smart TV

- Facial detection
- Gesture interaction



Smart door-lock

- Facial recognition
- Replacing physical keys





Robot cleaners

TEMPO

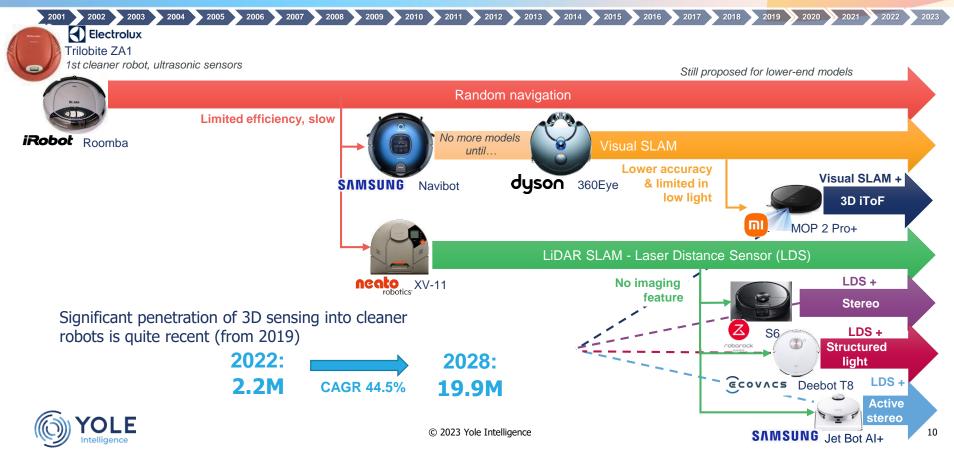
- Fitness guide
- Personal training



Smart fitness

Vacuum cleaner robots: from random navigation to 3D sensing





Going beyond the eight cameras per car benchmark

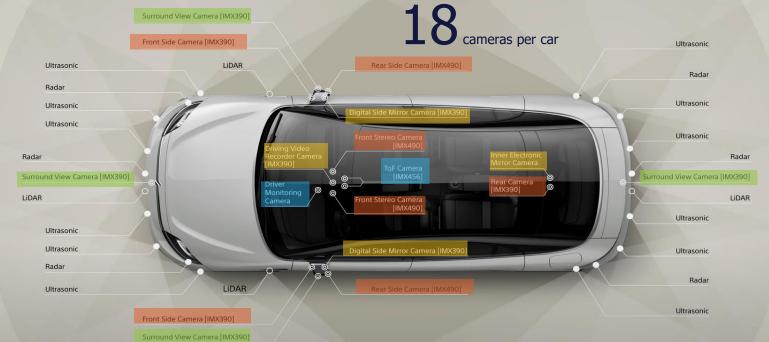
x7 ADAS cameras

x 3 DMS & ToF

x4 surround cameras

x4 eMirrors & recorder





courtesy of Sony

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sensors

Camera / ToF: 18

LiDAR: 4

Radar / Ultra Sonic: 18

A rationale for 18 cameras per car has emerged.

Driver monitoring – Use cases vs. technologies



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Complexity Computing power



- Position on seat
- Face recognition (high level)
- Smart airbag deployment



- Head position
- Eye direction monitoring
- Seatbelt detection
- Object detection
- Hands position on wheel
- Face recognition (low level)
- Eye position (for HUD and/or mirror adjustment)
- · Drowsiness detection
- Distraction detection



3D imaging is needed in order to obtain accurate depth estimation. This increases system complexity.



2D NIR or RGBIR image sensor can be used.

More complexity at the soft:

More complexity at the software level.



2D NIR image sensor is good enough to comply with regulation.



New opportunities for 3D sensing in automotive



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Exterior access Source: Cadillac





Occupancy monitoring system Source: EyeSight



Touchscreen

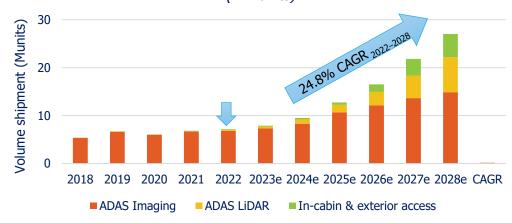


Source: Valeo



ADAS stereo camera Source: Ricoh

2018-2028 Automotive 3D camera market forecast (in Munits)



We expect 27 million automotive 3D cameras to be shipped in 2028, including more than 7 Munits for LiDAR and nearly 5 Munits for in-cabin and exterior access applications.

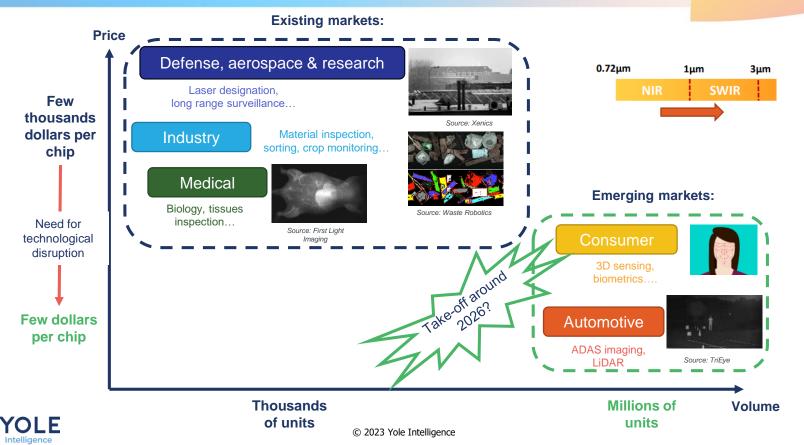


Technology trends



SWIR 3D sensing in consumer and automotive





SWIR imager manufacturers synthesis



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Technology	InGaAs	Ge-on-Si	Quantum dots	Organic photodiodes
Visual	InGaAs FPA Indium bumps Si ROIC	Ge FPA Si ROIC	QD film Si ROIC	Organic film Si ROIC
Manufacturing	InGaAs is grown on InP wafers, focal plane array is bonded to the Si ROIC thanks to Indium bumps at chip level.	Ge is grown on 8 or 12-inch Si wafer. It uses standard CMOS image sensors process.	Quantum dots (nanoparticles of PbS or InAs) are trapped in polymer ligands, film can be spin coated directly on the Si ROIC wafer.	The organic film is composed of several organic materials. Manufacturing is similar to quantum dots.
Maturity	++++	++	++	+
Price	\$1,000 - \$10,000	Target: \$1-\$100	Target: \$1-\$100	Target: \$1-\$100
Weaknesses	Price	Image quality (elevated dark current)	Robustness, response time of the material	Robustness, response time of the material
Players	SemiConductor Devices SONY TELEDYNE FLIR Everywhereyoulook GHOPTO W & many others	R&D Stratio,Inc. R&D TRIEYE (Yole's assumption)	iffe.augmented R&D R&D R&D	ISOFG SAMSUNG R&D R&D

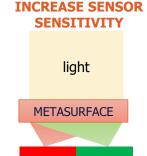


Metasurfaces: the ultimate evolution of flat optics





Source: Capasso group, Harvard university



BEAM STEERING Source: Lumotive



THINNER, **CHEAPER MODULE**

METASURFACE

Sensor

Color camera module



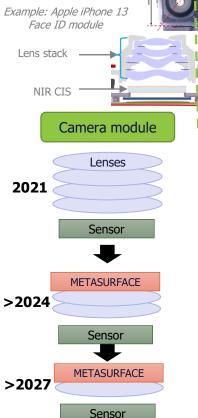
Active companies: (non-exhaustive)

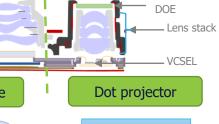






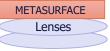




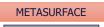












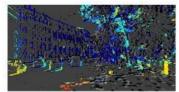
VCSEL

Event-based imaging for 3D sensing



- Event-based sensors use a neuromorphic and asynchronous structure: speed not limited by frame rate, minimal data loading, lower power, better latency, speed, sensitivity, intra-scene dynamics.
- Current applications include machine vision industrial cameras. Further applications are being demonstrated, as mobile live deblurring and 3D sensing (laser triangulation, structured light, stereo...).







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PROPHESEE

SAMSUNG











Application examples in 3D sensing:

Industrial inspection

Environment reconstruction **Hand tracking**

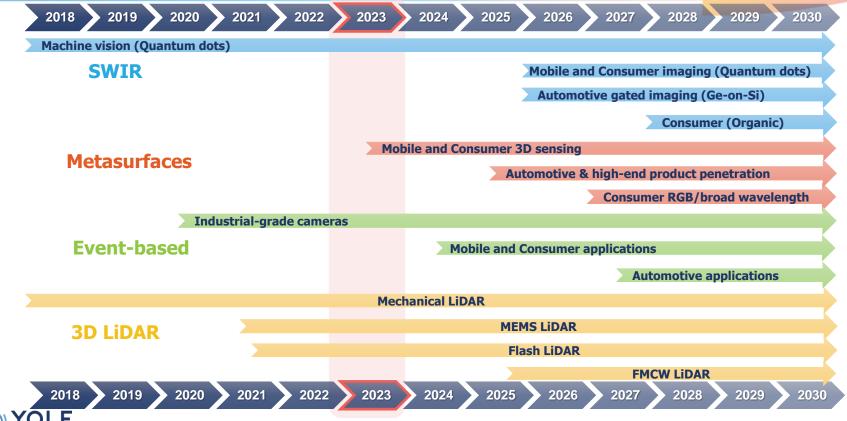




A roadmap proposal for emerging technologies



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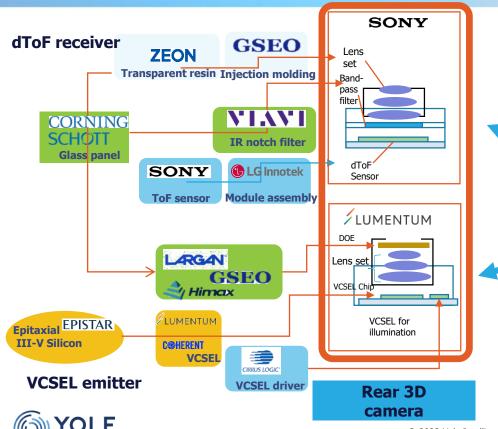


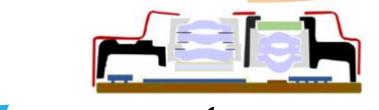
Industry and supply chain



Supply chain for rear 3D camera iPhone Pro "LIDAR"







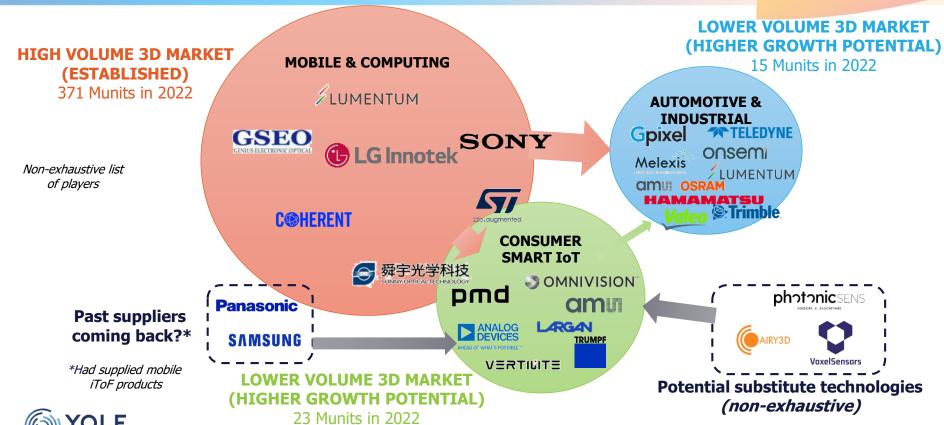


Estimated ASP: \$12

SPAD array sensors, for direct time-of-flight technology, have superior range and accuracy vs. indirect time-of-flight (used in Android phones), but the module is about 30% more expensive.

Supply chain dynamics between different markets



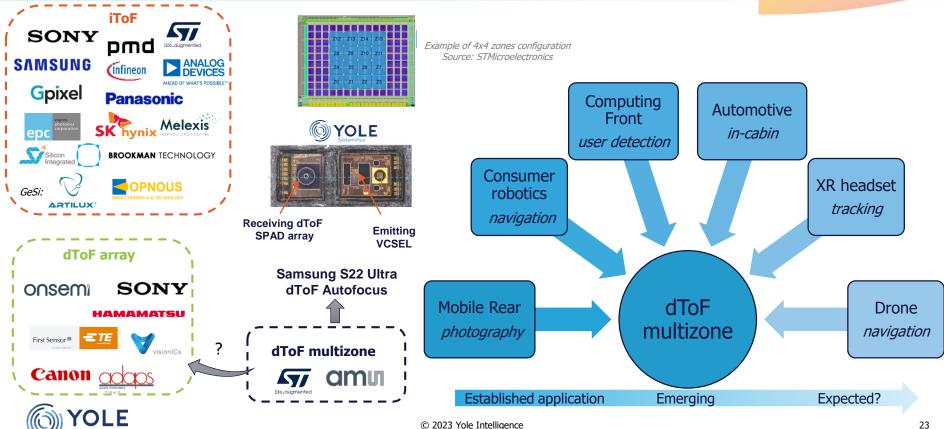


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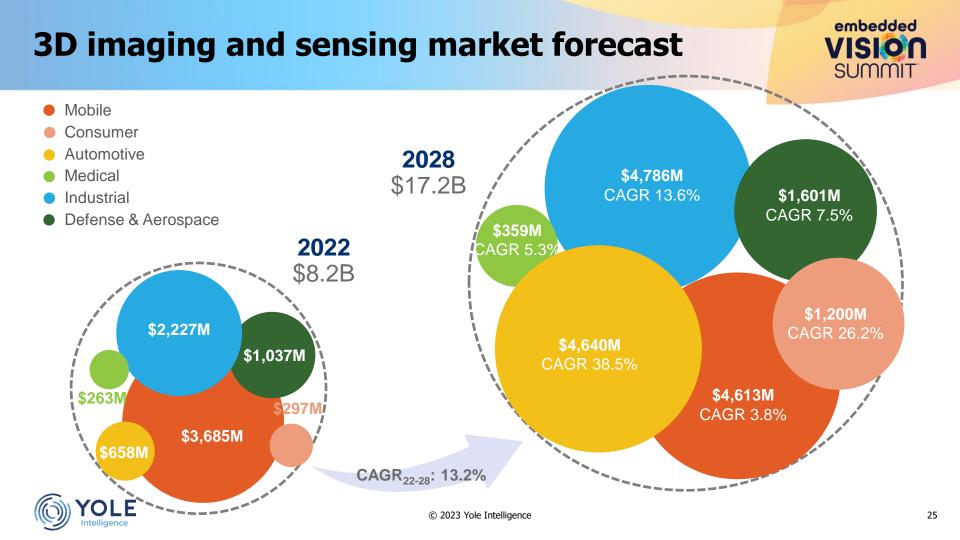
Time of Flight (ToF) sensor ecosystem





3D sensing market forecasts





Conclusion and outlook



- After reaching \$8.2B in 2022, the 3D imaging and sensing market is expected to more than double by 2028, to reach \$17.2B.
 - 409 million units were shipped, the majority of which were for the mobile market (>88%).
- Beyond mobile, 3D sensing is expanding to the other markets: consumer, automotive, medical, industrial, defense and aerospace.
- ToF technologies, both indirect and direct, are expected to expand further and represent 66% of 3D sensing revenues by 2028.
- Intense research and development to unlock new opportunities:
 - Smaller pixels, in pixel hybrid stacking, SWIR, FMCW LiDARs, metasurfaces, event-based sensing, single-camera technologies,...



Resources



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Yole Group resources

3D Imaging and Sensing 2023

https://www.yolegroup.com/product/report/3dimaging--sensing-2023/

SWIR Imaging 2023

https://www.yolegroup.com/product/report/swirimaging-2023/

Status of CMOS Image Sensor Industry 2022 https://www.yolegroup.com/product/report/status-of-cis-industry-2022/

Yole Group other related products https://www.yolegroup.com/products



2023 Embedded Vision Summit

"LiDAR Technologies and Markets: What's Changing?" (Talk) Business Insights, Wednesday, 11:25 am

